



NEWS

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C-MAC MicroTechnology joins the East of England Energy Group (EEEGR)



C-MAC MicroTechnology has joined the East of England Energy Group (EEEGR). EEEGR aims to bring together all the businesses and associations related to the energy industry in the East to form a world-class industry capable of competing in a global energy market.

With its extensive experience in the design, manufacture and test of high reliability components and systems for harsh environments such as the aerospace, automotive and space industries, C-MAC has the technologies and expertise to provide solutions to the microelectronic challenges facing the broad range of energy industries within the energy sector including oil, gas, nuclear and renewables.

John Best, CEO of EEEGR said he was pleased to welcome C-MAC into the organisation and added 'With its wealth of design and manufacturing experience for harsh environments, C-MAC is well-placed to both help develop robust solutions to the microelectronic challenges faced by the energy industry and at the same time find secure new markets by developing long term relationships'

I have been particularly impressed by the way that C-MAC has not only joined as a member but has immediately become actively engaged across the entire energy range. The Energy

Industry Seminar which they kindly hosted, in September chaired by Paul Hill, attracted senior players from the Oil and Gas, Renewables, Nuclear and Transmission sectors.'

Notes:

Headed by Indro Mukerjee, **C-MAC MicroTechnology** is the world leader in high-reliability electronic systems, modules and components for harsh environments such as extremes of temperature, vibration and shock. C-MAC operates primarily within the defence, aerospace, automotive, space, medical and specialised industrial sectors. The head office is in Wooburn Green, UK and the company has design and manufacturing facilities in the UK, France, Belgium and Canada, with additional dedicated sales and customer support teams throughout Europe and the USA. C-MAC has an extensive intellectual property portfolio and considerable electronics design and manufacturing expertise geared to its target industries.

Technologies and manufacturing processes at production sites at Great Yarmouth in the UK, Sherbrooke in Canada and Ronse in Belgium include thick-film printing on ceramic and other substrates, surface-mount hybrid circuits, DC/DC power modules, direct-attach flipchip, low-temperature cofired ceramic (LTCC), chip-on-board (COB), multichip module (MCM) assemblies and PCB assembly. These manufacturing resources are complemented by an integrated design-to-test service encompassing ASIC design as well as analogue, digital, RF, mixed-mode and thermal simulation. C-MAC also operates a UKAS-approved test facility, where an extensive range of product qualifications and tests are carried out to internationally recognized standards.